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PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

December 16, 2009

Applicants: Masashi KUMAGAI et al

For: COPPER ELECTROLYTIC SOLUTION AND  
ELECTROLYTIC COPPER FOIL PRODUCED THEREWITH

Serial No.: 10/531 645

Group: 1795

Confirmation No.: 1483

Filed: April 15, 2005

Examiner: Mendez

International Application No.: PCT/JP2003/013044

International Filing Date: October 10, 2003

Atty. Docket No.: 4700.P0312US

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**APPELLANTS' BRIEF ON APPEAL**

Sir:

This is an appeal from the decision of the Examiner dated July 23, 2009, finally rejecting Claims 4-8.

**REAL PARTY IN INTEREST**

Nikko Materials Co., Ltd. is the assignee of the present application and the real party in interest.

**RELATED APPEALS AND INTERFERENCES**

There are no related appeals and interferences to the present application.

12/23/2009 CNGUYEN2 00000010 10531645

STATUS OF CLAIMS 01 FC:1402

540.00 OP

Claims 1-3 have been canceled. Claims 4-8 are pending and are the claims under consideration on appeal.